

# MC34164, MC33164

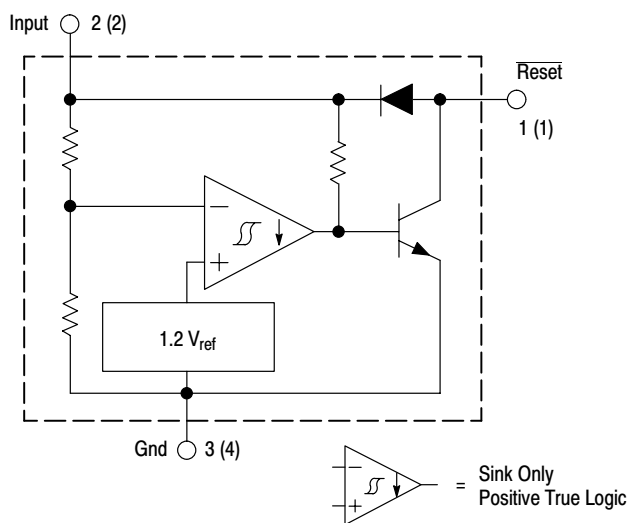
## Micropower Undervoltage Sensing Circuits

The MC34164 series are undervoltage sensing circuits specifically designed for use as reset controllers in portable microprocessor based systems where extended battery life is required. These devices offer the designer an economical solution for low voltage detection with a single external resistor. The MC34164 series features a bandgap reference, a comparator with precise thresholds and built-in hysteresis to prevent erratic reset operation, an open collector reset output capable of sinking in excess of 6.0 mA, and guaranteed operation down to 1.0 V input with extremely low standby current. These devices are packaged in 3-pin TO-226AA, 8-pin SO-8 and Micro-8 surface mount packages.

Applications include direct monitoring of the 3.0 or 5.0 V MPU/logic power supply used in appliance, automotive, consumer, and industrial equipment.

- Temperature Compensated Reference
- Monitors 3.0 V (MC34164-3) or 5.0 V (MC34164-5) Power Supplies
- Precise Comparator Thresholds Guaranteed Over Temperature
- Comparator Hysteresis Prevents Erratic Reset
- Reset Output Capable of Sinking in Excess of 6.0 mA
- Internal Clamp Diode for Discharging Delay Capacitor
- Guaranteed Reset Operation With 1.0 V Input
- Extremely Low Standby Current: As Low as 9.0  $\mu$ A
- Economical TO-226AA, SO-8 and Micro-8 Surface Mount Packages

Representative Block Diagram



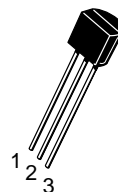
Pin numbers adjacent to terminals are for the 3-pin TO-226AA package.  
Pin numbers in parenthesis are for the 8-lead packages.

This device contains 28 active transistors.



ON Semiconductor

<http://onsemi.com>



TO-226AA  
P SUFFIX  
CASE 29

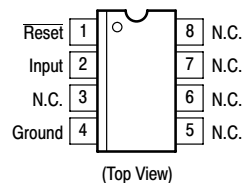


SO-8  
D SUFFIX  
CASE 751



Micro-8  
DM SUFFIX  
CASE 846A

### PIN CONNECTIONS



### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 7 of this data sheet.

### DEVICE MARKING INFORMATION

See general marking information in the device marking section on page 7 of this data sheet.

# MC34164, MC33164

## MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Power Input Supply Voltage	$V_{in}$	–1.0 to 12	V
Reset Output Voltage	$V_O$	–1.0 to 12	V
Reset Output Sink Current	$I_{Sink}$	Internally Limited	mA
Clamp Diode Forward Current, Pin 1 to 2 (Note 1)	$I_F$	100	mA
Power Dissipation and Thermal Characteristics P Suffix, Plastic Package Maximum Power Dissipation @ $T_A = 25^\circ\text{C}$ Thermal Resistance, Junction-to-Air D Suffix, Plastic Package Maximum Power Dissipation @ $T_A = 25^\circ\text{C}$ Thermal Resistance, Junction-to-Air DM Suffix, Plastic Package Maximum Power Dissipation @ $T_A = 25^\circ\text{C}$ Thermal Resistance, Junction-to-Air	$P_D$ $R_{\theta JA}$ $P_D$ $R_{\theta JA}$ $P_D$ $R_{\theta JA}$	700 178 700 178 520 240	mW $^\circ\text{C/W}$ mW $^\circ\text{C/W}$ mW $^\circ\text{C/W}$
Operating Junction Temperature	$T_J$	+150	$^\circ\text{C}$
Operating Ambient Temperature Range MC34164 Series MC33164 Series	$T_A$	0 to +70 – 40 to +125	$^\circ\text{C}$
Storage Temperature Range	$T_{stg}$	– 65 to +150	$^\circ\text{C}$

**NOTE:** ESD data available upon request.

## MC34164–3, MC33164–3 SERIES

**ELECTRICAL CHARACTERISTICS** (For typical values  $T_A = 25^\circ\text{C}$ , for min/max values  $T_A$  is the operating ambient temperature range that applies [Notes 2 & 3], unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
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### COMPARATOR

Threshold Voltage					V
High State Output ( $V_{in}$ Increasing)	$V_{IH}$	2.55	2.71	2.80	
Low State Output ( $V_{in}$ Decreasing)	$V_{IL}$	2.55	2.65	2.80	
Hysteresis ( $I_{Sink} = 100\ \mu\text{A}$ )	$V_H$	0.03	0.06	–	

### RESET OUTPUT

Output Sink Saturation ( $V_{in} = 2.4\ \text{V}$ , $I_{Sink} = 1.0\ \text{mA}$ ) ( $V_{in} = 1.0\ \text{V}$ , $I_{Sink} = 0.25\ \text{mA}$ )	$V_{OL}$	– –	0.14 0.1	0.4 0.3	V
Output Sink Current ( $V_{in}$ , $\overline{\text{Reset}} = 2.4\ \text{V}$ )	$I_{Sink}$	6.0	12	30	mA
Output Off-State Leakage ( $V_{in}$ , $\overline{\text{Reset}} = 3.0\ \text{V}$ ) ( $V_{in}$ , $\overline{\text{Reset}} = 10\ \text{V}$ )	$I_R(\text{leak})$	– –	0.02 0.02	0.5 1.0	$\mu\text{A}$
Clamp Diode Forward Voltage, Pin 1 to 2 ( $I_F = 5.0\ \text{mA}$ )	$V_F$	6.0	0.9	1.2	V

### TOTAL DEVICE

Operating Input Voltage Range	$V_{in}$	1.0 to 10	–	–	V
Quiescent Input Current $V_{in} = 3.0\ \text{V}$ $V_{in} = 6.0\ \text{V}$	$I_{in}$	– –	9.0 24	15 40	$\mu\text{A}$

- Maximum package power dissipation limits must be observed.
- Low duty cycle pulse techniques are used during test to maintain junction temperature as close to ambient as possible.
- $T_{low} = 0^\circ\text{C}$  for MC34164  
 $T_{low} = -40^\circ\text{C}$  for MC33164  
 $T_{high} = +70^\circ\text{C}$  for MC34164  
 $T_{high} = +125^\circ\text{C}$  for MC33164

# MC34164, MC33164

## MC34164–5, MC33164–5 SERIES

**ELECTRICAL CHARACTERISTICS** (For typical values  $T_A = 25^\circ\text{C}$ , for min/max values  $T_A$  is the operating ambient temperature range that applies [Notes 2 & NO TAG], unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
<b>COMPARATOR</b>					
Threshold Voltage					V
High State Output ( $V_{in}$ Increasing)	$V_{IH}$	4.15	4.33	4.45	
Low State Output ( $V_{in}$ Decreasing)	$V_{IL}$	4.15	4.27	4.45	
Hysteresis ( $I_{Sink} = 100\ \mu\text{A}$ )	$V_H$	0.02	0.09	–	
<b>RESET OUTPUT</b>					
Output Sink Saturation ( $V_{in} = 4.0\ \text{V}$ , $I_{Sink} = 1.0\ \text{mA}$ ) ( $V_{in} = 1.0\ \text{V}$ , $I_{Sink} = 0.25\ \text{mA}$ )	$V_{OL}$	– –	0.14 0.1	0.4 0.3	V
Output Sink Current ( $V_{in}$ , $\overline{\text{Reset}} = 4.0\ \text{V}$ )	$I_{Sink}$	7.0	20	50	mA
Output Off-State Leakage ( $V_{in}$ , $\overline{\text{Reset}} = 5.0\ \text{V}$ ) ( $V_{in}$ , $\overline{\text{Reset}} = 10\ \text{V}$ )	$I_R(\text{leak})$	– –	0.02 0.02	0.5 2.0	$\mu\text{A}$
Clamp Diode Forward Voltage, Pin 1 to 2 ( $I_F = 5.0\ \text{mA}$ )	$V_F$	0.6	0.9	1.2	V
<b>TOTAL DEVICE</b>					
Operating Input Voltage Range	$V_{in}$	1.0 to 10	–	–	V
Quiescent Input Current $V_{in} = 5.0\ \text{V}$ $V_{in} = 10\ \text{V}$	$I_{in}$	– –	12 32	20 50	$\mu\text{A}$

- Maximum package power dissipation limits must be observed.
- Low duty cycle pulse techniques are used during test to maintain junction temperature as close to ambient as possible.
- $T_{low} = 0^\circ\text{C}$  for MC34164  
 $T_{high} = +70^\circ\text{C}$  for MC34164  
 $= -40^\circ\text{C}$  for MC33164  
 $= +125^\circ\text{C}$  for MC33164

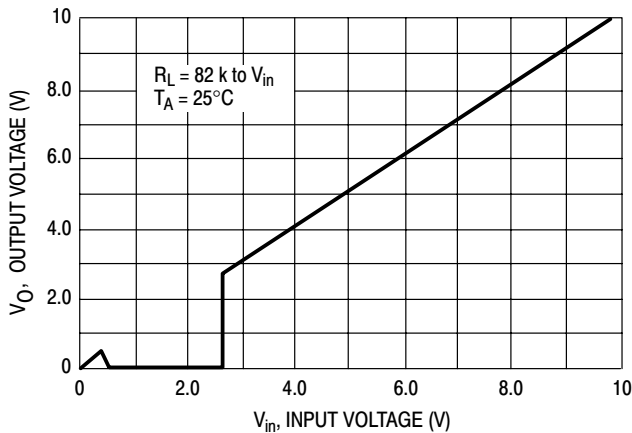


Figure 1. MC3X164–3  $\overline{\text{Reset}}$  Output Voltage versus Input Voltage

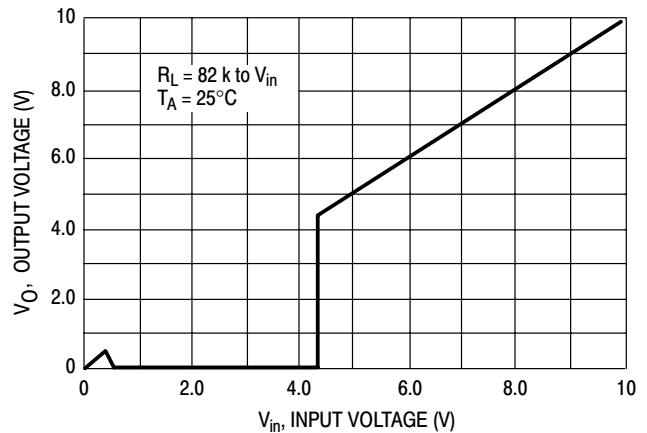
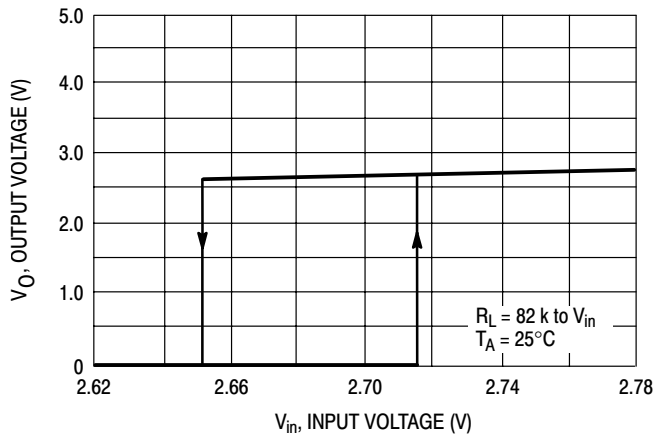
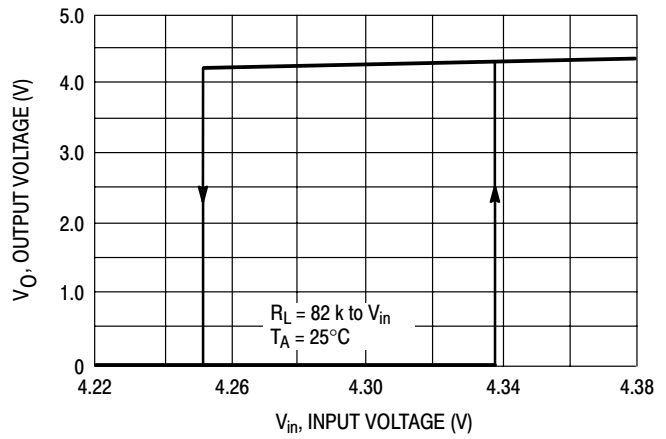


Figure 2. MC3X164–5  $\overline{\text{Reset}}$  Output Voltage versus Input Voltage

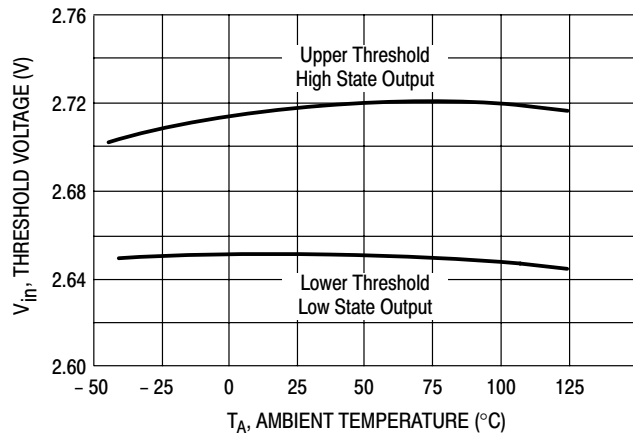
# MC34164, MC33164



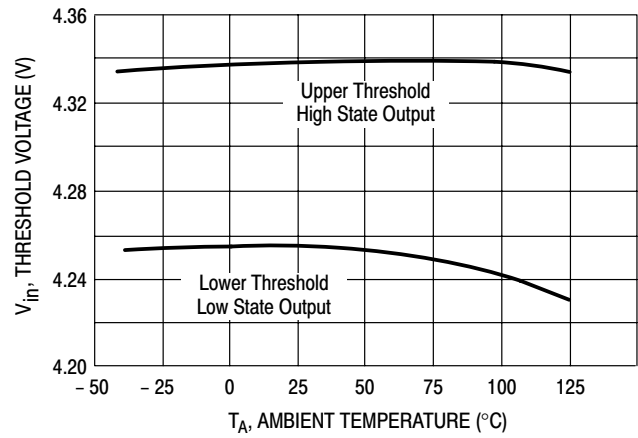
**Figure 3. MC3X164-3  $\overline{\text{Reset}}$  Output Voltage versus Input Voltage**



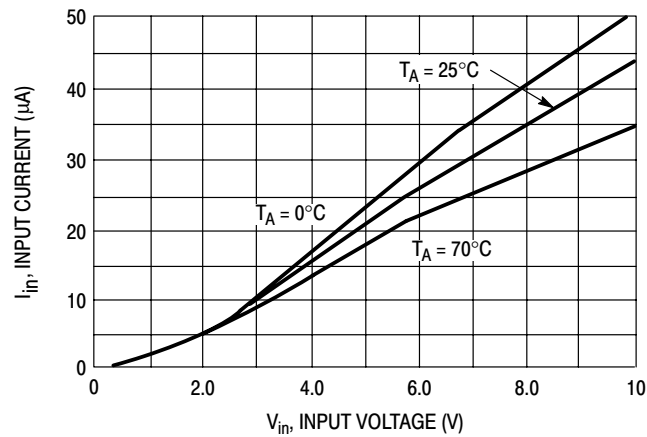
**Figure 4. MC3X164-5  $\overline{\text{Reset}}$  Output Voltage versus Input Voltage**



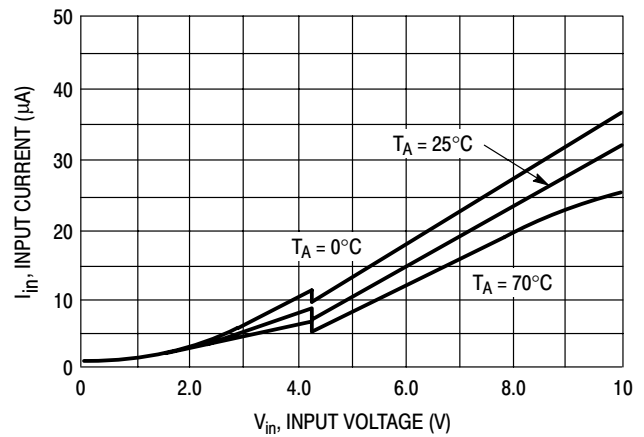
**Figure 5. MC3X164-3 Comparator Threshold Voltage versus Temperature**



**Figure 6. MC3X164-5 Comparator Threshold Voltage versus Temperature**

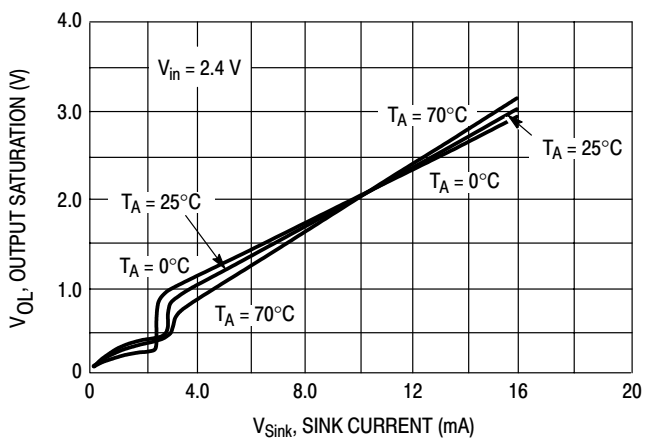


**Figure 7. MC3X164-3 Input Current versus Input Voltage**

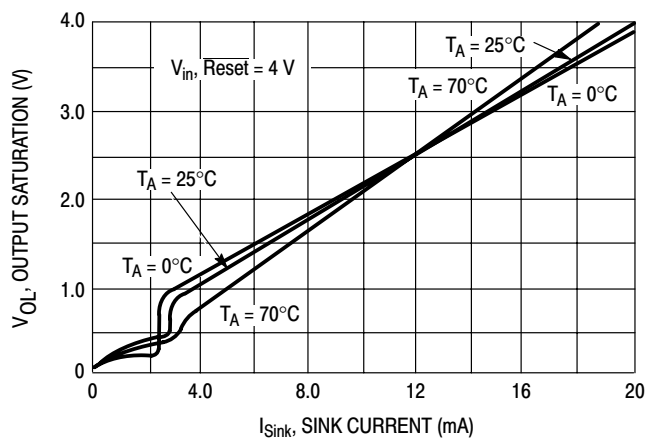


**Figure 8. MC3X164-5 Input Current versus Input Voltage**

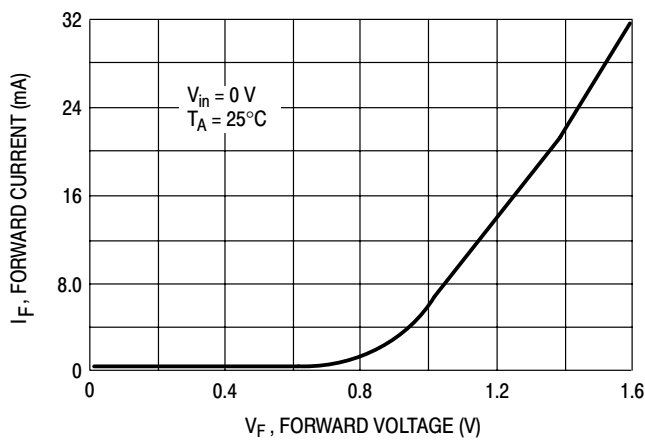
## MC34164, MC33164



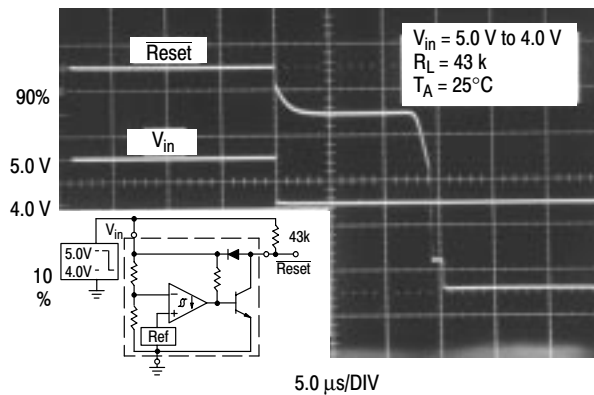
**Figure 9. MC3X164–3  $\overline{\text{Reset}}$  Output Saturation versus Sink Current**



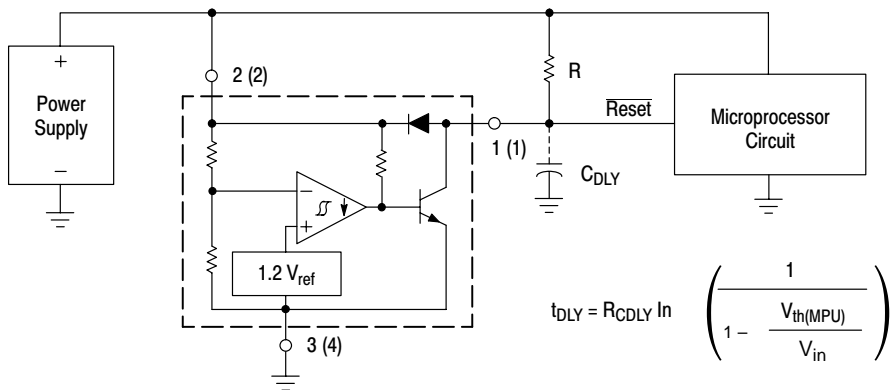
**Figure 10. MC3X164–5  $\overline{\text{Reset}}$  Output Saturation versus Sink Current**



**Figure 11. Clamp Diode Forward Current versus Voltage**



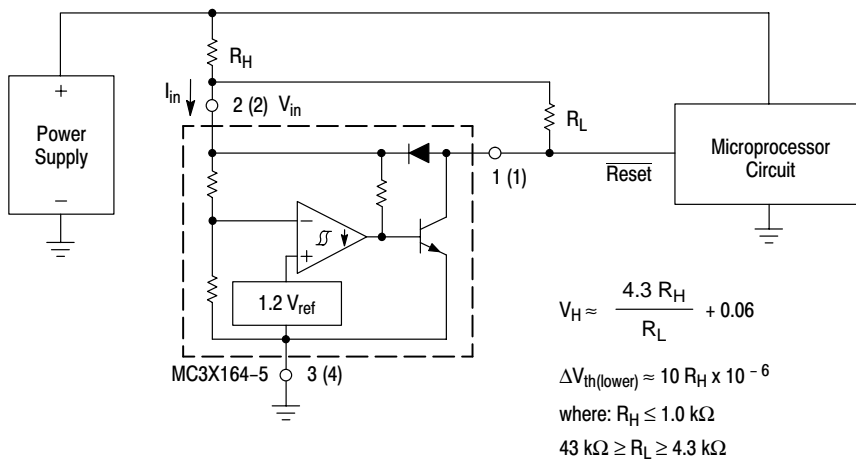
**Figure 12.  $\overline{\text{Reset}}$  Delay Time  
(MC3X164–5 Shown)**



A time delayed reset can be accomplished with the addition of  $C_{DLY}$ . For systems with extremely fast power supply rise times ( $< 500$  ns) it is recommended that the RCDLY time constant be greater than  $5.0 \mu s$ .  $V_{th}(MPU)$  is the microprocessor reset input threshold.

### Figure 13. Low Voltage Microprocessor Reset

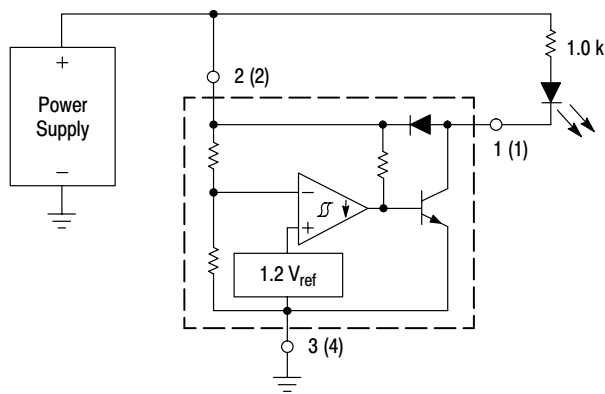
## MC34164, MC33164



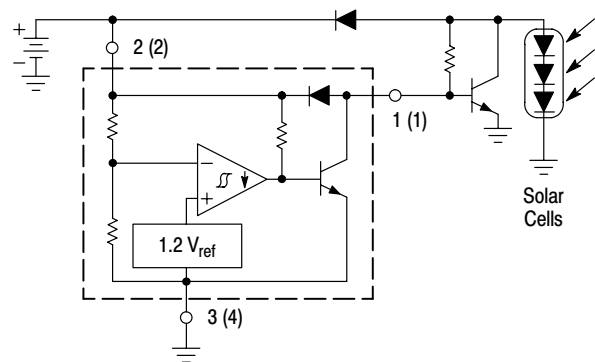
Test Data			
$V_H$ (mV)	$\Delta V_{th}$ (mV)	$R_H$ ( $\Omega$ )	$R_L$ ( $\text{k}\Omega$ )
60	0	0	43
103	1.0	100	10
123	1.0	100	6.8
160	1.0	100	4.3
155	2.2	220	10
199	2.2	220	6.8
280	2.2	220	4.3
262	4.7	470	10
306	4.7	470	8.2
357	4.7	470	6.8
421	4.7	470	5.6
530	4.7	470	4.3

Comparator hysteresis can be increased with the addition of resistor  $R_H$ . The hysteresis equation has been simplified and does not account for the change of input current  $I_{in}$  as  $V_{in}$  crosses the comparator threshold (Figure 8). An increase of the lower threshold  $\Delta V_{th(lower)}$  will be observed due to  $I_{in}$  which is typically  $10 \mu\text{A}$  at  $4.3 \text{ V}$ . The equations are accurate to  $\pm 10\%$  with  $R_H$  less than  $1.0 \text{ k}\Omega$  and  $R_L$  between  $4.3 \text{ k}\Omega$  and  $43 \text{ k}\Omega$ .

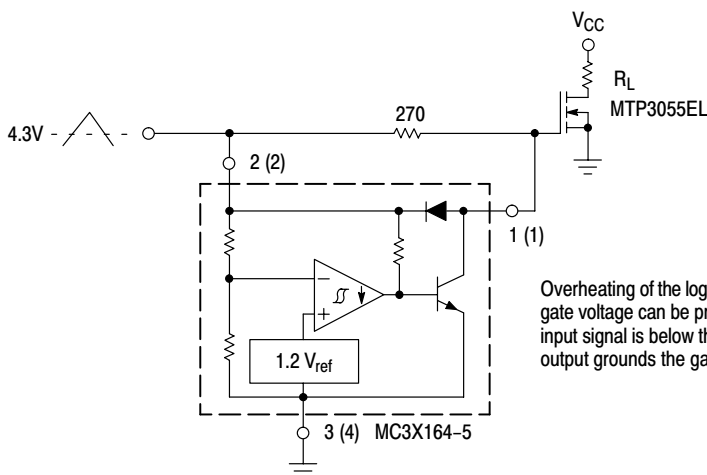
**Figure 14. Low Voltage Microprocessor Reset With Additional Hysteresis (MC3X164-5 Shown)**



**Figure 15. Voltage Monitor**



**Figure 16. Solar Powered Battery Charger**



Overheating of the logic level power MOSFET due to insufficient gate voltage can be prevented with the above circuit. When the input signal is below the  $4.3 \text{ V}$  threshold of the MC3X164-5, its output grounds the gate of the  $L^2$  MOSFET.

**Figure 17. MOSFET Low Voltage Gate Drive Protection Using the MC3X164-5**

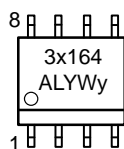
# MC34164, MC33164

## ORDERING INFORMATION

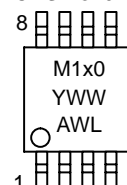
Device	Package	Shipping
MC33164D-3	SO-8	98 Units / Rail
MC33164D-3R2	SO-8	2500 Units / Tape & Reel
MC33164DM-3R2	Micro-8	2500 Units / Tape & Reel
MC33164P-3	TO-92	2000 Units / Box
MC33164P-3RA	TO-92	2000 Units / Tape & Reel
MC33164P-3RP	TO-92	2000 Units / Pack
MC33164D-5	SO-8	98 Units / Rail
MC33164D-5R2	SO-8	2500 Units / Tape & Reel
MC33164DM-5R2	Micro-8	2500 Units / Tape & Reel
MC33164P-5	TO-92	2000 Units / Box
MC33164P-5RA	TO-92	2000 Units / Tape & Reel
MC33164P-5RP	TO-92	2000 Units / Pack
MC34164D-3	SO-8	98 Units / Rail
MC34164D-3R2	SO-8	2500 Units / Tape & Reel
MC34164DM-3R2	Micro-8	2500 Units / Tape & Reel
MC334164P-3	TO-92	2000 Units / Box
MC34164P-3RP	TO-92	2000 Units / Pack
MC34164D-5	SO-8	98 Units / Rail
MC34164D-5R2	SO-8	2500 Units / Tape & Reel
MC34164DM-5R2	Micro-8	2500 Units / Tape & Reel
MC334164P-5	TO-92	2000 Units / Box
MC34164P-5RA	TO-92	2000 Units / Tape & Reel
MC34164P-5RP	TO-92	2000 Units / Pack

## MARKING DIAGRAMS

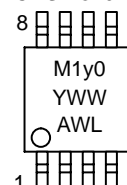
**SO-8  
D SUFFIX  
CASE 751**



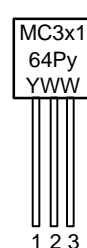
**Micro-8  
MC33164DM  
CASE 846A**



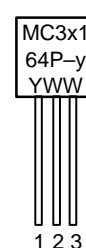
**Micro-8  
MC34164DM  
CASE 846A**



**TO-92  
MC3x164P-y  
CASE 29**



**TO-92  
MC3x164P-yRA  
MC3x164P-yRP  
CASE 29**

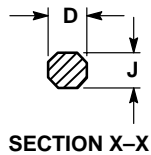
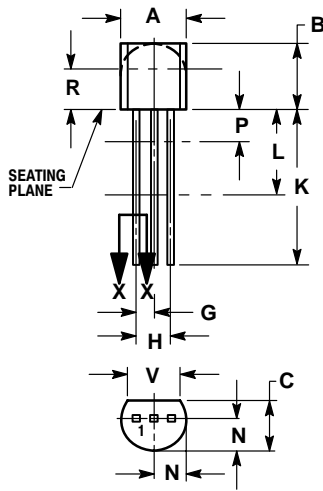


x = Device Number 3 or 4  
 y = Suffix Number 3 or 5  
 A = Assembly Location  
 WL, L = Wafer Lot  
 YY, Y = Year  
 WW, W = Work Week

# MC34164, MC33164

## PACKAGE DIMENSIONS

TO-226AA  
P SUFFIX  
CASE 29-11  
ISSUE AL

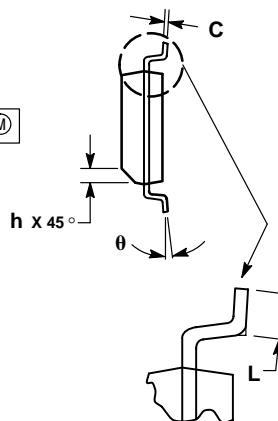
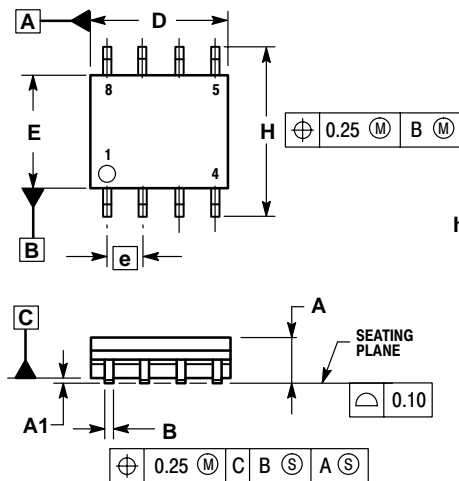


### NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED.
4. LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.175	0.205	4.45	5.20
B	0.170	0.210	4.32	5.33
C	0.125	0.165	3.18	4.19
D	0.016	0.021	0.407	0.533
G	0.045	0.055	1.15	1.39
H	0.095	0.105	2.42	2.66
J	0.015	0.020	0.39	0.50
K	0.500	---	12.70	---
L	0.250	---	6.35	---
N	0.080	0.105	2.04	2.66
P	---	0.100	---	2.54
R	0.115	---	2.93	---
V	0.135	---	3.43	---

SO-8  
D SUFFIX  
CASE 751-06  
ISSUE T



### NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. DIMENSIONS ARE IN MILLIMETER.
3. DIMENSION D AND E DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.
5. DIMENSION B DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 TOTAL IN EXCESS OF THE B DIMENSION AT MAXIMUM MATERIAL CONDITION.

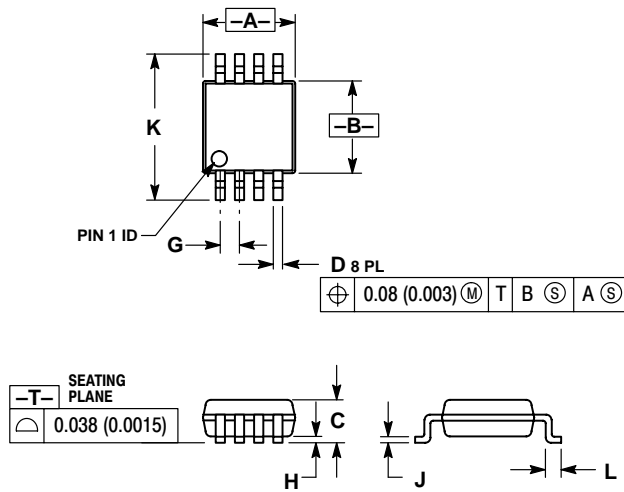
DIM	MILLIMETERS	
	MIN	MAX
A	1.35	1.75
A1	0.10	0.25
B	0.35	0.49
C	0.19	0.25
D	4.80	5.00
E	3.80	4.00
e	1.27 BSC	
H	5.80	6.20
h	0.25	0.50
L	0.40	1.25
theta	0°	7°



# MC34164, MC33164

## PACKAGE DIMENSIONS

Micro-8  
DM SUFFIX  
CASE 846A-02  
ISSUE E




### NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	2.90	3.10	0.114	0.122
B	2.90	3.10	0.114	0.122
C	---	1.10	---	0.043
D	0.25	0.40	0.010	0.016
G	0.65 BSC		0.026 BSC	
H	0.05	0.15	0.002	0.006
J	0.13	0.23	0.005	0.009
K	4.75	5.05	0.187	0.199
L	0.40	0.70	0.016	0.028

## **Notes**

## **Notes**

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